Ref #	Hits .	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	3504985	(die chip ic (integrated adj circuit) semiconductor flipchip (flip adj chip))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/17 21:10
L2	41197	(electrode terminal pad) with (embed embedding)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/17 21:11
L3	7464	1 same 2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/17 21:12
L4	121	3 same ((electro electrooptical) (electro adj3 optical))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/17 21:13